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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
10/710,908	08/12/2004	Min-Lung Huang	11573-US-PA	4907
31561 75	90 06/01/2005		EXAMINER	
JIANQ CHYUN INTELLECTUAL PROPERTY OFFICE			TRINH, HOA B	
7 FLOOR-1, N ROOSEVELT I	O. 100 ROAD, SECTION 2	•	ART UNIT	PAPER NUMBER
TAIPEI, 100	•		2814	
TAIWAN			DATE MAILED: 06/01/2009	5

Please find below and/or attached an Office communication concerning this application or proceeding.

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	Application No.	Applicant(s)			
	10/710,908	HUANG, MIN-LUNG			
Office Action Summary	Examiner	Art Unit			
	Vikki H. Trinh	2814			
The MAILING DATE of this communication apperiod for Reply	opears on the cover sheet v	vith the correspondence address			
A SHORTENED STATUTORY PERIOD FOR REPITHE MAILING DATE OF THIS COMMUNICATION  - Extensions of time may be available under the provisions of 37 CFR 1 after SIX (6) MONTHS from the mailing date of this communication.  - If the period for reply specified above is less than thirty (30) days, a re  - If NO period for reply is specified above, the maximum statutory period  - Failure to reply within the set or extended period for reply will, by statu Any reply received by the Office later than three months after the mailing earned patent term adjustment. See-37 CFR 1.704(b).	.136(a). In no event, however, may a ply within the statutory minimum of the will apply and will expire SIX (6) MO ite, cause the application to become A	reply be timely filed irty (30) days will be considered timely. NTHS from the mailing date of this communication. ABANDONED (35 U.S.C. § 133).			
Status					
1) Responsive to communication(s) filed on <u>03/</u>					
2a)⊠ This action is <b>FINAL</b> . 2b)□ This action is non-final. 3)□ Since this application is in condition for allowance except for formal matters, prosecution as to the merits is					
closed in accordance with the practice under	•				
	Ex parte Quayre, 1999 O.	D. 11, 455 O.G. 215.			
Disposition of Claims					
4) Claim(s) 1-9 is/are pending in the application					
4a) Of the above claim(s) is/are withdra	awn from consideration.				
5) Claim(s) is/are allowed.		•			
6)⊠ Claim(s) <u>1-9</u> is/are rejected. 7)□ Claim(s) is/are objected to.					
8) Claim(s) is/are objected to.	/or election requirement				
	or cicolion requirement.				
Application Papers					
9) The specification is objected to by the Examir	ner.	•			
10)⊠ The drawing(s) filed on <u>12 August 2004</u> is/are		•			
Applicant may not request that any objection to the					
Replacement drawing sheet(s) including the corre					
11) The oath or declaration is objected to by the E	Examiner. Note the attache	ed Office Action of form PTO-152.			
Priority under 35 U.S.C. § 119					
12)⊠ Acknowledgment is made of a claim for foreig a)□ All b)□ Some * c)⊠ None of:	n priority under 35 U.S.C.	§ 119(a)-(d) or (f).			
1. Certified copies of the priority documer	nts have been received.	•			
2. Certified copies of the priority documer	nts have been received in	Application No			
3. Copies of the certified copies of the pri	•	n received in this National Stage			
application from the International Bures					
* See the attached detailed Office action for a lis	st of the certified copies no	t received.			
Attachment(s)					
Attachment(s)  1) Notice of References Cited (PTO-892)	4) T Interview	Summary (PTO-413)			
2) Notice of Draftsperson's Patent Drawing Review (PTO-948)	· · · · · · · · · · · · · · · · · · ·	(s)/Mail Date			

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Paper No(s)/Mail Date \_\_\_\_\_.

2) Notice of Draftsperson's Patent Drawing Review (PTO-948)

3) Information Disclosure Statement(s) (PTO-1449 or PTO/SB/08)

5) Notice of Informal Patent Application (PTO-152)

6) Other: \_\_\_\_.

Art Unit: 2814

#### **DETAILED ACTION**

# Acknowledgement

Claims 1-9 are pending. The following rejection is in response to an amendment filed on March 15, 2005.

## Claim Rejections - 35 USC § 112

- 1. The following is a quotation of the first paragraph of 35 U.S.C. 112:
  - The specification shall contain a written description of the invention, and of the manner and process of making and using it, in such full, clear, concise, and exact terms as to enable any person skilled in the art to which it pertains, or with which it is most nearly connected, to make and use the same and shall set forth the best mode contemplated by the inventor of carrying out his invention.
- 2. Claim 9 is rejected under 35 U.S.C. 112, first paragraph, as failing to comply with the written description requirement. The claim(s) contains subject matter which was not described in the specification in such a way as to reasonably convey to one skilled in the relevant art that the inventor(s), at the time the application was filed, had possession of the claimed invention. For example, in claim 9, line 4, the newly amended phrase "... and within" does not have any support in the original disclosure, including the drawings. Further, all of the drawings show that the spacing pad disposed on the bonding pad, and not within the bonding pad.

## Claim Rejections - 35 USC § 102

1. The following is a quotation of the appropriate paragraphs of 35 U.S.C. 102 that form the basis for the rejections under this section made in this Office action:

A person shall be entitled to a patent unless -

(e) the invention was described in (1) an application for patent, published under section 122(b), by another filed in the United States before the invention by the applicant for patent or (2) a patent granted on an application for patent by another filed in the United States before the invention by the applicant for patent, except that an international application filed under the treaty defined in section 351(a) shall have the effects for purposes of this subsection of an application filed in the United States only if the international application designated the United States and was published under Article 21(2) of such treaty in the English language.

2. Claims 1, 2, and 7-9 are rejected under 35 U.S.C. 102(e) as being anticipated by Kung et al. (hereinafter Kung) (US 2005/0012211 A1).

As to claim 1, Kung discloses a chip structure having a chip 10 (fig. 4B) with an active surface 12 (fig. 4B) and at least one bonding pad 16 (fig. 4B); a first passivation layer 14 (fig. 4B) disposed on the active surface 12 and included at least a first opening (fig. 4B) exposing the bonding pad 16; and a spacing pad 412 (fig. 4B) entirely disposed on the bonding pad 16 (fig. 4B) within the first opening (fig. 4B).

As to claim 2, the structure has a metallic bump pad 416 (fig. 4B) connected to the spacing pad 412 or 414 (fig. 4B) and covering the surrounding of the first opening 106 (fig. 4B).

As to claim 7, the UBM layer 424 covering the top surface of the spacing pad 412 (fig. 4B) and the surrounding area of the first opening (fig. 4B).

As to claim 8, a conductive bump 18 connected to the UBM layer 424 or 416 (fig. 4B).

As to claim 9, a conductive structure having a spacing pad 412 (fig. 4B) entirely disposing on a bonding pad 16 (fig. 4B); a metallic bump pad 416 (fig. 4B); and a bump 422 (fig. 4B) having a base in contact with the planar top surface of the metallic bump pad 416 (fig. 4B).

## Claim Rejections - 35 USC § 103

- 3. The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:
  - (a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.

Application/Control Number: 10/710,908

Art Unit: 2814

- 4. The factual inquiries set forth in *Graham* v. *John Deere Co.*, 383 U.S. 1, 148 USPQ 459 (1966), that are applied for establishing a background for determining obviousness under 35 U.S.C. 103(a) are summarized as follows:
  - 1. Determining the scope and contents of the prior art.
  - 2. Ascertaining the differences between the prior art and the claims at issue.
  - 3. Resolving the level of ordinary skill in the pertinent art.
  - 4. Considering objective evidence present in the application indicating obviousness or nonobviousness.
- 5. This application currently names joint inventors. In considering patentability of the claims under 35 U.S.C. 103(a), the examiner presumes that the subject matter of the various claims was commonly owned at the time any inventions covered therein were made absent any evidence to the contrary. Applicant is advised of the obligation under 37 CFR 1.56 to point out the inventor and invention dates of each claim that was not commonly owned at the time a later invention was made in order for the examiner to consider the applicability of 35 U.S.C. 103(c) and potential 35 U.S.C. 102(e), (f) or (g) prior art under 35 U.S.C. 103(a).
- 6. Claims 3-6 are rejected under 35 U.S.C. 103(a) as being unpatentable over Kung, as applied to claim 1 above, in view of Farnworth (6,815,327).

Kung discloses the invention substantially as claimed. However, Kung does not explicitly teach that the chip structure includes a second passivation layer with a second opening.

Farnworth discloses a chip structure having a wafer 1004 (fig. 2h) with a circuit 100 (fig. 2h), a bonding pad 1002 (fig. 2h), a first passivation layer 1006 (fig. 2h); a conductive (metal) pad 1016 (fig. 2h) continuously connecting to a spacing pad 1016 which covers the first opening; a second passivation layer 1018 (fig. 2h) with a second opening (fig. 2h) disposed over the first passivation layer 1006 (fig. 2h), thereby exposing the metal bump pad 1016(fig. 2h).

Application/Control Number: 10/710,908

Art Unit: 2814

Kung and Farnworth are in the same field of improving a UBM chip structure.

Therefore, as to claims 3-4, it would have been obvious to one skilled in the art at the time the invention was made to modify the invention of Kung with a second passivation layer having a second opening, as taught by Farnworth, so as to provide additional support for the chip structure.

As to claims 5 and 6, Kung discloses a conductive bump 422 connected to the UBM layer/pad 414 or 412 (fig. 4B).

#### Response to Arguments

7. Applicant's arguments with respect to claims 1-9 have been considered but are most in view of the new ground(s) of rejection.

#### **Conclusion**

Applicant's amendment necessitated the new ground(s) of rejection presented in this Office action. Accordingly, **THIS ACTION IS MADE FINAL**. See MPEP § 706.07(a). Applicant is reminded of the extension of time policy as set forth in 37 CFR 1.136(a).

A shortened statutory period for reply to this final action is set to expire THREE MONTHS from the mailing date of this action. In the event a first reply is filed within TWO MONTHS of the mailing date of this final action and the advisory action is not mailed until after the end of the THREE-MONTH shortened statutory period, then the shortened statutory period will expire on the date the advisory action is mailed, and any extension fee pursuant to 37 CFR 1.136(a) will be calculated from the mailing date of the advisory action. In no event, however, will the statutory period for reply expire later than SIX MONTHS from the date of this final action.

Art Unit: 2814

Any inquiry concerning this communication or earlier communications from the Examiner should be directed to Vikki Trinh whose telephone number is (571) 272-1719. The Examiner can normally be reached from Monday-Friday, 9:00 AM - 5:30 PM Eastern Time. If attempts to reach the examiner by telephone are unsuccessful, the Examiner's supervisor, Mr. Wael Fahmy, can be reached at (571) 272-1705. The office fax number is 703-872-9306.

Any request for information regarding to the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Also, status information for published applications may be obtained from either Private PAIR or Public Pair. In addition, status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see <a href="http://pair-direct.uspto.gov">http://pair-direct.uspto.gov</a>. If you have questions pertaining to the Private PAIR system, please contact the Electronic Business Center (EBC) at 866-217-9197 (toll free).

Lastly, paper copies of cited U.S. patents and U.S. patent application publications will cease to be mailed to applicants with Office actions as of June 2004. Paper copies of foreign patents and non-patent literature will continue to be included with office actions. These cited U.S. patents and patent application publications are available for download via the Office's PAIR. As an alternate source, all U.S. patents and patent application publications are available on the USPTO web site (www.uspto.gov), from the Office of Public Records and from commercial sources. Applicants are referred to the Electronic Business Center (EBC) at <a href="http://www.uspto.gov/ebc/index.html">http://www.uspto.gov/ebc/index.html</a> or 1-866-217-9197 for information on this policy. Requests to restart a period for response due to a missing U.S. patent or patent application publications will not be granted.

Vikki Trinh,
Patent Examiner
AU 2814

HOWARD WEISS PRIMARY EXAMINER